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ZigBee PRO and IEEE802.15.4 JN5169-001-M0x-2 modules Rev. 1.0 — 15 June 2016 User mai

User manual

Document information

Info	Content
Keywords	JN5169, Zigbee, module
Abstract	JN5169-001-M0x-2 modules user manual



ZigBee PRO and IEEE802.15.4 JN5169-001-M0x-2 modules

Revision history

Rev	Date	Description
1.0	20160613	Initial version

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ZigBee PRO and IEEE802.15.4 JN5169-001-M0x-2 modules

1. General description

The JN5169-001-M0x-2 (with x=0, 3 or 6) module family provides designers with a ready-made component that provides a fully integrated solution for applications, using the IEEE802.15.4 standard in the 2.4 GHz - 2.5 GHz ISM frequency band, including ZigBee Smart Energy, Home Automation and ZigBee 3.0 and can be quickly and easily included in product designs. The modules integrate all of the RF components required, removing the need to perform expensive RF design and test. Products can be designed by simply connecting sensors and switches to the module IO pins. The module uses NXP's single chip IEEE802.15.4 wireless microcontroller, allowing designers to make use of the extensive chip development support material. Hence, these modules allow designers to bring wireless applications to market in the minimum time with significantly reduced development effort and cost.

3 variants are available: JN5169-001-M00-2, JN5169-001-M03-2 and JN5169-001-M06-2.

The variants available are described in the Table 1.

1.1 Variants and identifications information

Table 1. Variants and identifications information

Type number	Description	FCCID	IC ID	ANATEL ID
JN5169-001-M00-2	Standard power, integrated printed antenna	XXMJN5169M0V2	8764A-JN5169M0	<tbd></tbd>
JN5169-001-M03-2	Standard power, µFL connector	XXMJN5169M3V2	8764A-JN5169M3	<tbd></tbd>
JN5169-001-M06-2	High power, μFL connector	XXMJN5169M6V2	8764A-JN5169M6	<tbd></tbd>

1.2 Regulatory approvals

The JN5169-001-M0x-2 has been tested against the requirements of the following European standards.

- Radio EN 300 328 v 1.9.1
- EMC, EN 301 489-17 v 2.2.1, EN 62479 2010, EN 301 489-1 v 1.9.2
- Basic Safety Assessment (BSA) EN 60950-1:2006

A Notified Body statement of opinion for this standard is available on request.

The High-power module with M06 suffix is not approved for use in Europe.

All module types have received FCC "Modular Approval", in compliance with CFR 47 FCC part 15 regulations and in accordance to FCC public notice DA00-1407. The modular approvals notice and test reports are available on request.

Additionally, all module types have also received ANATEL "Modular Approval"

2. Features and benefits

2.1 Benefits

· Microminiature module solutions

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- · Ready to use in products
- Minimises product development time
- · No RF test required for systems
- · Compliant with:
 - FCC 47CFR Part 15C
 - ETSI EN 300-328 V1.9.1
 - EN 301-489-17 V2.2.1
 - EN60950-1-2006
 - ANATEL
- Temperature range: -40 °C to +85 °C
- Lead-free and RoHS compliant

2.2 Features: modules

- 2.4 GHz IEEE 802.15.4, ZigBee Smart Energy and Home Automation compatible
- JN5169-001-M00-2
 - Dimensions: 16 mm × 30 mm
 - Integrated printed antenna
 - TX power 8.5 dBm/10 dBm
 - Receiver sensitivity -96.5 dBm
 - TX current 27.2 mA at 10 dBm
 - TX current 23.6 mA at 8.5 dBm
 - RX current 17.8 mA at maximum input level 10 dBm
 - RX current 16.2 mA at maximum input level 0 dBm
 - 2.0 V/3.6 V operation
- JN5169-001-M03-2
 - Dimensions: 16 mm × 21 mm
 - μFl connector
 - TX power 8.5 dBm/10 dBm
 - Receiver sensitivity -96.5 dBm
 - TX current 27.2 mA at 10 dBm
 - TX current 23.6 mA at 8.5 dBm
 - RX current 17.8 mA at maximum input level 10 dBm
 - RX current 16.2 mA at maximum input level 0 dBm
 - 2.0 V/3.6 V operation
- JN5169-001-M06-2
 - Dimensions: 16 mm × 30 mm
 - μFl connector
 - TX power 21 dBm
 - Receiver sensitivity -100 dBm

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- TX current 181 mA at 21 dBm
- RX current 22.8 mA
- 2.0 V/3.6 V operation

2.3 Features: microcontroller

- 32-bit RISC CPU; 1 MHz to 32 MHz clock speed
- Variable instruction width for high coding efficiency
- Multi-stage instruction pipeline
- 512 kB Flash
- 32 kB RAM
- 4 kB EEPROM
- Data EEPROM with guaranteed 100 k write operations
- ZigBee PRO stack with Home Automation and Smart Energy profiles
- 2-wire I²C-bus compatible serial interface; can operate as either master or slave
- 5 × PWM (4 timers, 1 timer/counter)
- 2 low-power sleep counters
- 2 UARTs
- SPI-bus Master and Slave port, 3 selects
- Supply voltage monitor with 8 programmable thresholds
- 6-input 10-bit ADC, comparator
- Battery and temperature sensors
- Watchdog and Supply Voltage Monitor (SVM)
- Up to 20 Digital IO (DIO) pins

3. Applications

- Robust and secure low-power wireless applications
- ZigBee Smart Energy networks
- ZigBee Home Automation networks
- ZigBee 3.0 networks
- Toys and gaming peripherals
- Energy harvesting for example, self-powered light switch

4. Overview

The JN5169-001-M0x-2 family is a range of ultra-low power, high performance surface mount modules targeted at IEEE 802.15.4, ZigBee Smart Energy, Home Automation and ZigBee 3.0 networking applications, enabling users to realize products with minimum time to market and at the lowest cost. It removes the need for expensive and lengthy development of custom RF board designs and test suites. The module uses NXP's JN5169 wireless microcontroller to provide a comprehensive solution with large memory, high CPU and radio performance and all RF components included. All that is required to

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develop and manufacture wireless control or sensing products is to connect a power supply and peripherals such as switches, actuators and sensors, considerably simplifying product development.

3 module variants are available:

- JN5169-001-M00-2 with an integrated printed antenna
- JN5169-001-M03-2 with a μFL antenna connector
- $\bullet\,$ JN5169-001-M06-2 with a μFL antenna connector and also a power amplifier and LNA for extended range

5. Marking

5.1 JN5169-001-M00-2 and JN5169-001-M03-2

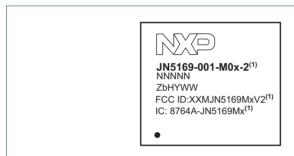


Fig 1. JN5169-001-M00-2 and JN5169-001-M03-2 packages marking (top view)

Table 2. Marking code

Line number	Marking code
Line 1	NXP Logo: B&W outline logo
Line 2	part ID: JN5169-001-M0x-2[1]
Line 3	serial number: NNNNN
Line 4	PMC code: ZbHYWW
	Z: SSMC
	b: SPIL
	H: Halogen free
	Y: year
	WW: week
Line 5	FCC ID: XXMJN5169MxV2[1]
Line 6	IC: 8764A-JN5169Mx ^[1]

[1] With x = 0 or 3.

The JN5169-001-M0x-2 (with x = 0 or 3) family modules meet the requirements of Directive 2002/95/EC of the European Parliament and of the Council on the Restriction of Hazardous Substance (RoHS) and of the Chinese RoHS requirements SJ/T11363-2006 which came into force on 1st March 2007.

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5.2 JN5169-001-M06-2



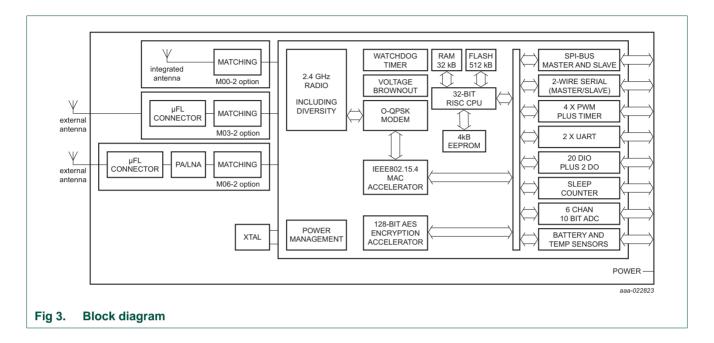
Table 3. Marking code

Line number	Marking code
Line 1	NXP Logo: B&W outline logo
Line 2	part ID: JN5169-001-M06-2
Line 3	serial number: NNNNN
Line 4	PMC code: ZbHYWW
	Z: SSMC
	b: SPIL
	H: Halogen free
	Y: year
	WW: week
Line 5	FCC ID: XXMJN5169M6V2
Line 6	IC: 8764A-JN5169M6

The JN5169-001-M06-2 module meets the requirements of Directive 2002/95/EC of the European Parliament and of the Council on the Restriction of Hazardous Substance (RoHS) and of the Chinese RoHS requirements SJ/T11363-2006 which came into force on 1st March 2007.

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6. Block diagram

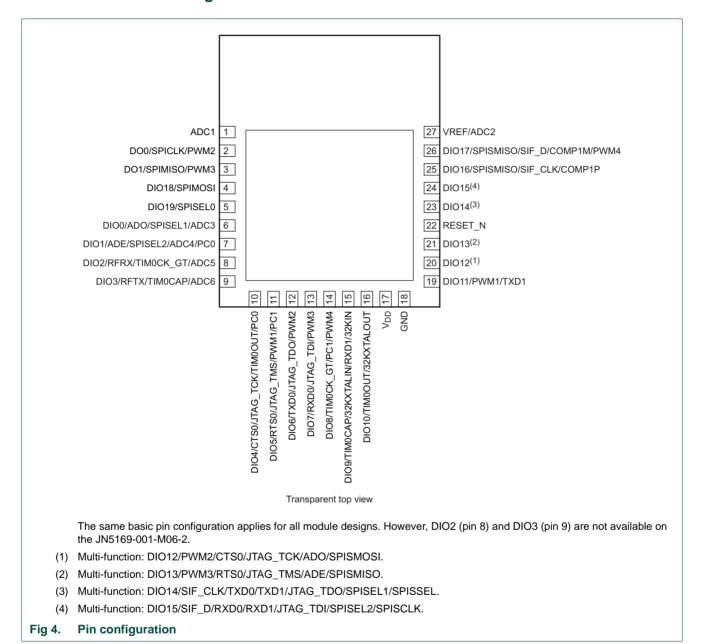


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7. Pinning information

7.1 Pinning



7.2 Pin description

Table 4. Pin description

Symbol	Pin	Type[1]	Description
ADC1	1	I	ADC1 — ADC input

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Table 4. Pin description ... continued

Symbol	Pin	Type[1]	Description	
DO0/SPICLK/PWM2[2]	2	0	DO0 — DO0	
			SPICLK — SPI-bus master clock output	
			PWM2 — PWM2 output	
DO1/SPIMISO/PWM3[3]	3	I/O	DO1 — DO1	
			SPIMISO — SPI-bus Master In, Slave Out input	
			PWM3 — PWM3 output	
DIO18/SPIMOSI	4	I/O	DIO18 — DIO18	
			SPIMOSI — SPI-bus Master Out Slave In output	
DIO19/SPISEL0	5	I/O	DIO19 — DIO19	
			SPISEL0 — SPI-bus Master Select Output 0	
DIO0/ADO/SPISEL1/ADC3	6	I/O	DIO0 — DIO0	
			ADO — antenna diversity odd output	
			SPISEL1 — SPI-bus master select output 1	
			ADC3 — ADC input: ADC3	
DIO1/ADE/SPISEL2/ADC4/PC0	7	I/O	DIO1 — DIO1	
			ADE — antenna diversity even output	
			SPISEL2 — SPI-bus master select output 2	
			ADC4 — ADC input: ADC4	
			PC0 — pulse counter 0 input	
DIO2/RFRX/TIM0CK_GT/ADC5[4]	8	I/O	DIO2 — DIO2	
			RFRX — radio receives control output	
			TIM0CK_GT — timer0 clock/gate input	
			ADC5 — ADC input: ADC5	
DIO3/RFTX/TIM0CAP/ADC6[4]		I/O	DIO3 — DIO3	
			RFTX — radio transmit control output	
			TIM0CAP — timer0 capture input	
			ADC6 — ADC input: ADC6	
DIO4/CTS0/JTAG_TCK/TIM0OUT/PC0	10	I/O	DIO4 — DIO4	
			CTS0 — UART 0 clear to send input	
			JTAG_TCK — JTAG CLK input	
			TIM0OUT — timer0 PWM output	
			PC0 — pulse counter 0 input	
DIO5/RTS0/JTAG_TMS/PWM1/PC1	11	I/O	DIO5 — DIO5	
			RTS0 — UART 0 request to send output	
			JTAG_TMS — JTAG mode select input	
			PWM1 — PWM1 output	
			PC1 — pulse counter 1 input	
DIO6/TXD0/JTAG_TDO/PWM2	12	I/O	DIO6 — DIO6	
			TXD0 — UART 0 transmit data output	
			JTAG_TDO — JTAG data output	
			PWM2 — PWM2 data output	

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Table 4. Pin description ... continued

Symbol	Pin	Type[1]	Description	
DIO7/RXD0/JTAG_TDI/PWM3	13	I/O	DIO7 — DIO7	
			RXD0 — UART 0 receive data input	
			JTAG_TDI — JTAG data input	
			PWM3 — PWM 3 data output	
DIO8/TIM0CK_GT/PC1/PWM4	14	I/O	DIO8 — DIO8	
			TIM0CK_GT — timer0 clock/gate input	
			PC1 — pulse counter1 input	
			PWM4 — PWM 4 output	
DIO9/TIM0CAP/32KXTALIN/RXD1/32KIN	15	I/O	DIO9 — DIO9	
			TIM0CAP — Timer0 Capture input	
			32KXTALIN — 32 kHz External Crystal input	
			RXD1 — UART1 Receive Data input	
			32KIN — 32 kHz External clock input	
DIO10/TIM0OUT/32KXTALOUT	16	I/O	DIO10 — DIO10	
			TIM0OUT — Timer0 PWM Output	
			32KXTALOUT — 32 kHz External Crystal output	
V_{DD}	17	Р	V _{DD} — supply voltage	
GND	18	GND	ground	
DIO11/PWM1/TXD1	19	I/O	DIO11 — DIO11	
			PWM1 — PWM1 output	
			TXD1 — UART1 Transmit Data output	
DIO12 ^[5]	20	I/O	DIO12 — DIO12	
			PWM2 — PWM2 output	
			CTS0 — UART0 clear to send input	
			JTAG_TCK — JTAG CLK input	
			ADO — antenna diversity odd output	
			SPISMOSI — SPI-bus slave Master Out, Slave In input	
DIO13 ^[6]	21	I/O	DIO13 — DIO13	
			PWM3 — PWM3 output	
			RTS0 — UART0 request to send output	
			JTAG_TMS — JTAG mode select input	
			ADE — antenna diversity even output	
			SPISMISO — SPI-bus slave master in slave out output	
RESET_N	22	I	RESET_N — reset input	
DIO14[7]	23	I/O	DIO14 — DIO14	
			SIF_CLK — serial interface clock	
			TXD0 — UART 0 transmit data output	
			TXD1 — UART 1 transmit data output	
			JTAG_TDO — JTAG data output	
			SPISEL1 — SPI-bus master select output 1	
			SPISSEL — SPI-bus slave select input	

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Table 4. Pin description ... continued

Symbol	Pin	Type ^[1]	Description
DIO15[8]	24	I/O	DIO15 — DIO15
			SIF_D — serial interface data
			RXD0 — UART 0 receive data input
			RXD1 — UART 1 receive data input
			JTAG_TDI — JTAG data input
			SPISEL2 — SPI-bus master select output 2
			SPISCLK — SPI-bus slave clock input
DIO16/SPISMOSI/SIF_CLK/COMP1P	25	I/O	DIO16 — DIO16
			COMP1P — comparator positive input
			SIF_CLK — Serial Interface clock
			SPISMOSI — SPI-bus Slave Master Out Slave In input
DIO17/SPISMISO/SIF_D/COMP1M	26	I/O	DIO17 — DIO17
			COMP1M — COMP1M; comparator negative input
			SIF_D — Serial Interface Data
			SPISMISO — SPI-bus Slave Master In Slave Out output
			PWM4 — PWM 4 output
VREF/ADC2	27	Р	VREF — analog peripheral reference voltage
		I	ADC2 — ADC input 2

- [1] P = power supply; G = ground; I = input, O = output; I/O = input/output.
- [2] JTAG programming mode: must be left floating high during reset to avoid entering JTAG programming mode.
- [3] UART programming mode: leave pin floating high during reset to avoid entering UART programming mode or hold it low to program.
- [4] Not available on the JN5169-001-M06-2 since they are used to control the front-end module.
- [5] Multi-function: DIO12/PWM2/CTS0/JTAG TCK/ADO/SPISMOSI.
- [6] Multi-function: DIO13/PWM3/RTS0/JTAG_TMS/ADE/SPISMISO.
- [7] Multi-function: DIO14/SIF_CLK/TXD0/TXD1/JTAG_TD0/SPISEL1/SPISSEL.
- [8] Multi-function: DIO15/SIF_D/RXD0/RXD1/JTAG_TDI/SPISEL2/SPISCLK.

8. Functional description

8.1 JN5169 single chip wireless microcontroller

The JN5169-001-M0x-2 is constructed around the JN5169-001 single chip wireless microcontroller, which includes the radio system, a 32-bit RISC CPU, Flash, RAM and EEPROM memory and a range of analogue and digital peripherals.

The chip is described fully in JN5169 Wireless Microcontroller Datasheet (see Ref. 2).

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8.2 Peripherals

Table 5. Peripherals

Peripherals	JN5169-001-M0x-2	Notes
Master SPI-bus port	3 selects	250 kHz - 16 MHz
Slave SPI-bus port	1	250 kHz - 4 MHz
UART	2	16550 compatible
Two-wire serial I/F (compatible with SMbus and I ² C-bus)	1	Up to 400kHz
PWM		16 MHz clock
timer	4	
timer/counter	1	
Programmable Sleep Timers	2	32 kHz clock
Digital IO lines (multiplexed with UARTs, timers and SPI-bus selects)	20	DIO2 and DIO3 are not available on JN5169-001-M06 modules
Analog-to-Digital converter	4	10-bit, up to 100 ks/s
Programmable analogue comparator	1	ultra low power mode for sleep
Internal temperature sensor	1	
Internal battery sensor	1	

The performance of all peripherals is defined in the JN5169 Wireless Microcontroller Datasheet (see Ref. 2).

NXP supplies all the development tools and networking stacks needed to enable end-product development to occur quickly and efficiently. These are all freely available from the NXP Wireless Connectivity TechZone (see Ref. 3). A range of evaluation/developer kits is also available, allowing products to be quickly bread boarded. Efficient development of software applications is enabled by the provision of a complete, unlimited, software developer kit. Together with the available libraries for the IEEE802.15.4 MAC and ZigBee PRO network stacks, this package provides everything required to develop application code and to trial it with hardware representative of the final module.

The modules can be user programmed both in development and in production using software supplied by NXP. Access to the on-chip peripherals, MAC and network stack software is provided through specific APIs. This information is available on the NXP support website, together with many example applications, user guides, reference manuals and application notes.

9. Limiting values

Table 6. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.3	+3.6	V
V _{VREF/ADC2}	voltage on pin VREF/ADC2		-0.3	V _{DDA} + 0.3V	V
V _{ADC1}	voltage on pin ADC1		-0.3	V _{DDA} + 0.3V	V

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Table 6. Limiting values ...continued

Symbol	Parameter	Conditions	Min	Max	Unit
V _{IO(dig)}	digital input/output voltage		-0.3	V _{DDD} + 0.3V	V
T _{stg}	storage temperature		-40	+150	°C
V _{ESD}	electrostatic discharge voltage	according to ETSI EN 301 489-17 2012 V2.2.1 and ETSI EN 301 489-1 2011 V1.9.2	4	-	kV

10. Recommended operating conditions

Table 7. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage	[1]	2	3.6	V
T _{amb}	ambient temperature	standard range	-40	+85	°C

^[1] To reach the maximum TX power, 2.8 V is the minimum.

11. Characteristics

11.1 DC current

Table 8. Active processing

 V_{DD} = 2 V to 3.6 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{DD}	supply current	M00					
		radio in receive mode; maximum input level at 10 dBm		-	17.8	-	mA
		radio in receive mode; maximum input level at 0 dBm		-	16.7	-	mA
		radio in transmit mode 10 dBm	[1]	-	27.2	-	mA
		radio in transmit mode 8.5 dBm	[1]	-	23.6	-	mA
		M03					
		radio in receive mode; maximum input level at 10 dBm		-	17.8	-	mA
		radio in receive mode; maximum input level at 0 dBm		-	16.7	-	mA
		radio in transmit mode 10 dBm	[1]	-	27.2	-	mA
		radio in transmit mode 8.5 dBm	[1]	-	23.6	-	mA
		M06					
		radio in receive mode		-	22.8	-	mA
		radio in transmit mode	[1]	-	181	-	mA

^[1] To reach the maximum TX power, 2.8 V is the minimum.

Table 9. Sleep mode

 V_{DD} = 2 V to 3.6 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{DD(IO)}	1 1 11 7	in sleep mode; with I/O and RC oscillator timer wake-up; T_{amb} = 25 $^{\circ}C$	-	0.73	-	μΑ

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Table 10. Deep sleep mode

 V_{DD} = 2 V to 3.6 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Тур	Max	Unit
I_{DD}	supply current	deep sleep mode; measured at 25 °C	-	70	-	nA

[1] Waiting on chip RESET or I/O event.

11.2 AC characteristics

11.2.1 Radio transceiver

These modules meet all the requirements of the IEEE802.15.4 standard over 2.0 V to 3.6 V and offers the improved RF characteristics shown in <u>Table 11</u>. All RF characteristics are measured single ended.

Table 11. RF port characteristics

Single-ended; Impedance = 50 $\Omega^{(1)}$, $V_{DD} = 2 V$ to 3.6 V; $T_{amb} = -40 ^{\circ}$ C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{range}	frequency range		2.4	•	2.485	GHz

^[1] With external matching inductors and assuming PCB layout.

Table 12. Radio transceiver characteristics: +25 °C

 $V_{DD} = 2 \text{ V to } 3.6 \text{ V; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Receiver						•
M00						
S _{RX}	receiver sensitivity	nominal for 1 % PER, as per 802.15.4	-	-96.5	-	dBm
P _{i(RX)(max)}	maximum receiver input power	1 % PER, measured as sensitivity; supply current at 17.8 mA	-	10	-	dBm
		1 % PER, measured as sensitivity; supply current at 16.2 mA	-	0	-	dBm
$\Delta \alpha_{RSSI}$	RSSI variation	−95 dBm to −10 dBm; available through UM11016 Integrated Peripherals API	-4	-	+4	dB
M03			,			'
S _{RX}	receiver sensitivity	nominal for 1 % PER, as per 802.15.4	-	-96.5	-	dBm
P _{i(RX)(max)}	maximum receiver input power	1 % PER, measured as sensitivity; supply current at 17.8 mA	-	10	-	dBm
		1 % PER, measured as sensitivity; supply current at 16.2 mA	-	0	-	dBm
$\Delta \alpha_{RSSI}$	RSSI variation	−95 dBm to −10 dBm; available through UM11016 Integrated Peripherals API	-4	-	+4	dB
M06			,			'
S _{RX}	receiver sensitivity	nominal for 1 % PER, as per 802.15.4	-	-100	-	dBm
P _{i(RX)(max)}	maximum receiver input power	1 % PER, measured as sensitivity	-	5	-	dBm
$\Delta \alpha_{RSSI}$	RSSI variation	−100 dBm to −25 dBm; available through UM11016 Integrated Peripherals API	-4	-	+4	dB
Transmitte	r		l		1	

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Table 12. Radio transceiver characteristics: +25 °C ...continued

 $V_{DD} = 2 \text{ V to } 3.6 \text{ V; unless otherwise specified.}$

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
M00		,					
Po	output power	I _{DD} = 27.2 mA	[1]	-	10	-	dBm
		I _{DD} = 23.6 mA	[1]	-	8.5	-	dBm
P _{o(cr)}	control range output power	in 6 major steps and then 4 fine steps	[2]	-	-42	-	dB
M03							
Po	output power	$I_{DD} = 27.2 \text{ mA}$	[1]	-	10	-	dBm
		$I_{DD} = 23.6 \text{ mA}$	[1]	-	8.5	-	dBm
P _{o(cr)}	control range output power	in 6 major steps and then 4 fine steps	[2]	-	-42	-	dB
M06	<u>'</u>					'	
Po	output power		[1]	-	21	-	dBm

^[1] To reach the maximum TX power, 2.8 V is the minimum on V_{DD}.

12. Federal Communication Commission Statement

- This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules see Ref. 4. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no quarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:
 - Reorient or relocate the receiving antenna
 - Increase the separation between the equipment and receiver
 - Connect the equipment into an outlet on a circuit different from that to which the receiver is connected
 - Consult the dealer or an experienced radio/TV technician for help
- **OEM** integrators instructions
 - The OEM integrators are responsible for ensuring that the end-user has no manual instructions to remove or install module
 - The module is limited to installation in mobile or fixed applications, according to CFR 47 Part 2.1091(b)
 - Separate approval is required for all other operating configurations, including portable configurations with respect to CFR 47 Part 2.1093 and different antenna configurations
- User guide mandatory statements

^[2] Up to an extra 2.5 dB of attenuation is available if required.

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- User's instructions of the host device must contain the following statements in addition to operation instructions:
 - * "This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:
 - (1) This device may not cause harmful interference, and
 - (2) This device must accept any interference received, including interference that may cause undesired operation"
 - * "Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment"

FCC RF Exposure requirements

 User's instructions of the host device must contain the following instructions in addition to operation instructions:

Avoid direct contact to the antenna, or keep it to a 20 cm minimum distance while using this equipment. This device must not be collocated or operating in conjunction with another antenna or transmitter.

The JN5169-001-M03-2 and JN5169-001-M06-2 modules have been designed to operate with antennas having a maximum gain of 2 dBi. Antennas having a gain greater than 2 dBi are strictly prohibited for use with these devices. The required antenna impedance is 50 ohms.

The JN5169-001-M00-2 integrates a printed antenna. The maximum gain of the printed antenna is 1 dBi.

12.1 FCC end product labelling

The final 'end product' should be labelled in a visible area with the following:

"Contains TX FCC ID: XXMJN5169M0V2, XXMJN5169M3V2 or XXMJN5169M6V2" to reflect the version of the module being used inside the product.

13. Industry Canada statement

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

This device complies with Industry Canada RF radiation exposure limits set forth for general population (uncontrolled exposure). This device must be installed to provide a separation distance of at least 20 cm from all persons and must not be collocated or operating in conjunction with any other antenna or transmitter.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) il ne doit pas produire de brouillage, et (2) l'utilisateur du dispositif doit être prêt a accepter tout brouillage radioélectrique reçu, même si ce brouillage est susceptible de compromettre le fonctionnement du dispositif.

Le présent appareil est conforme aux niveaux limites d'exigences d'exposition RF aux personnes définies par Industrie Canada. Cet appareil doit être installé afin d'offrir une distance de séparation d'au moins 20 cm avec l'utilisateur, et ne doit pas être installé à proximité ou être utilisé en conjonction avec une autre antenne ou un autre émetteur.

To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropic radiated power (e.i.r.p.) is not more than that permitted for successful communication.

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The JN5169-001-M03-2 and JN5169-001-M06-2 modules have been designed to operate with antennas having a maximum gain of 2 dBi. Antennas having a gain greater than 2 dBi are strictly prohibited for use with these devices. The required antenna impedance is 50 ohms.

The JN5169-001-M00-2 integrates a printed antenna. The maximum gain of the printed antenna is 1 dBi.

As long as the above condition is met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc).

13.1 Industry Canada end product labelling

For Industry Canada purposes the following should be used:

14. "Contains Industry Canada ID IC: 8764A-JN5169Mx" (with x = 0 or 3 or 6).

Footprint information for reflow soldering

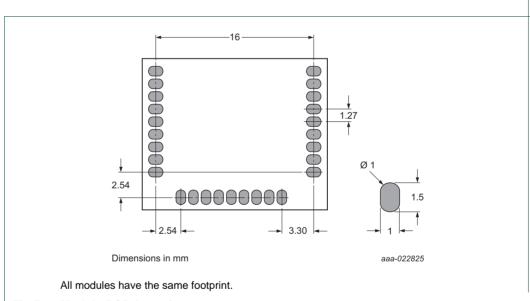
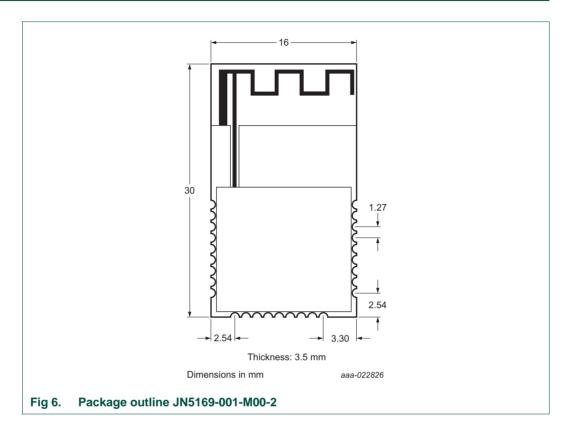
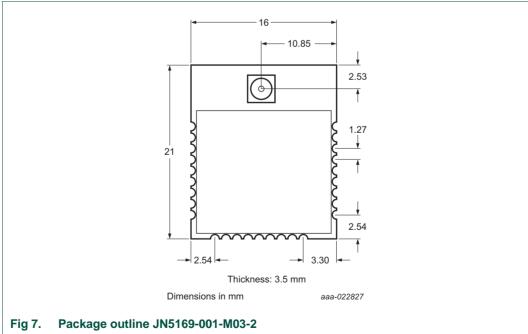


Fig 5. Module PCB footprint

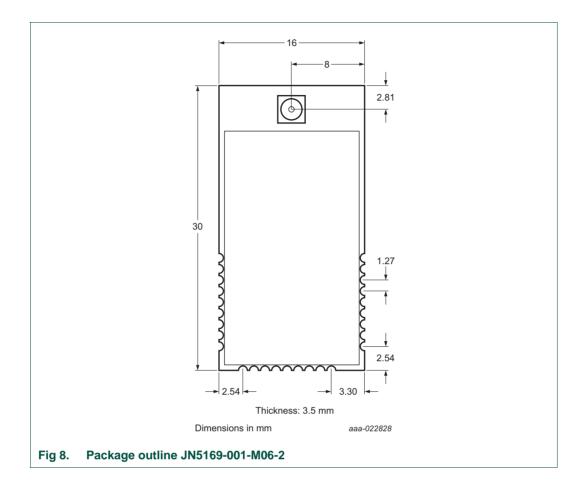
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15. Package outline





ZigBee PRO and IEEE802.15.4 JN5169-001-M0x-2 modules



ZigBee PRO and IEEE802.15.4 JN5169-001-M0x-2 modules

16. Abbreviations

Table 13. Abbreviations

Acronym	Description
API	Application Program Interface
ADC	Analog to Digital Converter
FCC	Federal Communication Commission
Ю	Input Output
OEM	Original Equipment Manufacturer
PCB	Printed Circuit Board
PER	Packet Error Rate
PWM	Pulse Width Modulation
R&TTE	Radio and Telecommunications Terminal Equipment
RF	Radio Frequency
RISC	Reduce Instruction Set Computing
RSSI	Receive Signal Strength Indicator
RTS	Request-To-Send
SPI	Serial Peripheral Interface
SVM	Supply Voltage Monitor
SYNTH	SYNTHesizer
UART	Universal Asynchronous Receiver/Transmitter

17. References

- [1] IEEE Std 802.15.4-2011 IEEE Std 802.15.4-2011 IEEE Standard for Information Technology.
- [2] JN5169 JN5169 wireless microcontroller datasheet.
- [4] Part 15 of the FCC Rules http://www.ecfr.gov/cgi-bin/text-idx?SID=d01e00935bfcb0d53b914e7c8e63f383 &node=47:1.0.1.1.16&rgn=div5

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